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To the Honorable Commissioner of Patents and Trademarks: Please Record the attached original documents or copy thereof.

1. Name of conveying party(ies):

Garnik Taheri

Additional name of conveying party(ies) attached? ☐ Yes ☒ No

2. Name and address of receiving party(ies)

Name: SMART Modular Technologies, Inc.

Internal Address:

Street Address: 4211 Starboard Drive

City: Fremont State: CA Zip: 94538

Additional Name(s) & address(es) attached? ☐ Yes ☒ No

3. Nature of conveyance:

- ☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other

Execution Date: February 11, 2004

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is:

A. Patent Application No.(s)
10/754,807

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning this document should be mailed:

Name: Thelen Reid & Priest LLP

Internal Address:

Street Address: P. O. Box 640640

City: San Jose State: CA Zip: 95164

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41)\$ 40

- ☐ Enclosed
☒ Authorized to be charged to deposit account

8. Deposit account number:

50-1698

(Attach duplicate copy of this page if paying by deposit account)

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Thierry K. Lo

Name of Person Signing

Signature

Date

Total number of pages including cover sheet, attachments, and documents: 2

Mail documents to be recorded with required cover sheet information to:
Commissioner of Patents & Trademarks, Box Assignments
Washington, D.C. 20231

PATENT
REEL: 014992 FRAME: 0159

ASSIGNMENT

WHEREAS, I, Garnik Taheri, a citizen of the United States of America, residing at 5424 Century Park Way, San Jose, CA 95111, have invented a "Single IC Packing Solution for Multi Chip Modules" for which I have executed application papers for a U.S. patent thereon which was filed on January 8, 2004, having Application No. 10/754,807; and

WHEREAS, SMART Modular Technologies, Inc., a California corporation, having a place of business located at 4211 Starboard Drive, Fremont, CA 94538, is desirous of acquiring the exclusive right, title and interest in and to said invention and in and to the Letters Patent to be granted and issued therefor in the United States of America and its territories and possessions, and all countries foreign thereto;

NOW, THEREFORE, for a valuable consideration, the receipt of which is hereby acknowledged, I, Garnik Taheri, do sell, assign, transfer and set over unto the said SMART Modular Technologies, Inc., its successors and assigns, the full and exclusive right, title and interest in and to said invention, and in and to any and all Letters Patent to be granted and issued therefor, not only for, to and in the United States of America, its territories and possessions, but also for, to and in all other countries including all priority rights under the International Convention; and we hereby authorize and request the Commissioner of Patents and Trademarks to issue said Letters Patent to said SMART Modular Technologies, Inc., its successors and assigns, in accordance with this Assignment.



Garnik Taheri



Date